

Analysis and Simulation of Charge Collection Efficiency in Si Thin Detectors

M. Petasecca^{1,3}, F.Moscatelli^{1,2,3}, G.U. Pignatelli^{1,3}

¹ DIEI - Università di Perugia, via G.Duranti,93 - Italy

² IMM-CNR sez.di Bologna, via Gobetti 101 – Italy

³ INFN sez. Perugia – via Pascoli, 10 - Italy



Outline

- Radiation damage modelling
- Simulation of Silicon Thin structures:
 - Depletion Voltage as a function of Fluence
 - Charge Collection Efficiency as a function of thickness and Fluence



Simulation Tool

- **Simulation tool:**
 - ISE-TCAD ver. 6.1 – discrete time and spatial solutions to equations
- **Damage modelling:**
 - Deep levels: E_t , σ_n and σ_p
 - SRH statistics
 - Effects: high density defect concentration (clusters)
produces an increase of the leakage current – variation of doping concentration and CCE

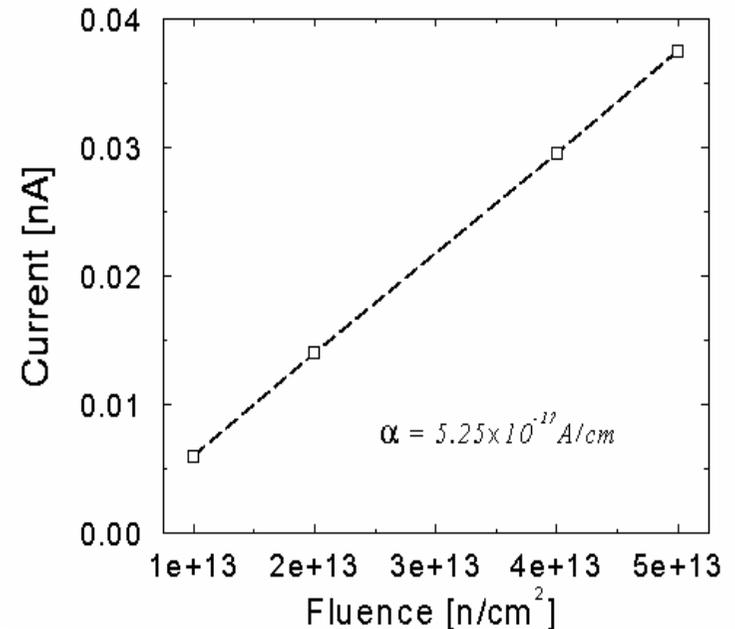
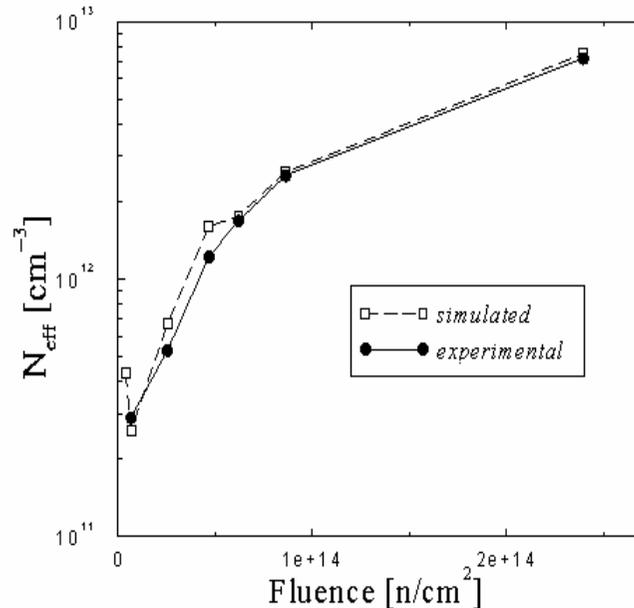


Three-level model

- Level characteristics*:

	Acceptor	Acceptor	Donor
E	$E_c - 0.42\text{eV}$	$E_c - 0.50\text{eV}$	$E_v + 0.36\text{eV}$
σ_p	$8 \cdot 10^{-15}\text{cm}^2$	10^{-15}cm^2	10^{-16}cm^2
σ_n	10^{-16}cm^2	10^{-16}cm^2	10^{-15}cm^2
η	26cm^{-1}	0.1cm^{-1}	1cm^{-1}

Comparison between simulated and experimental data shows that results have been well reproduced



*Passeri, D.; et al.
 Nuclear Science, IEEE
 Transactions on , vol.
 48 (2001).



Thin detectors

- Thin detectors have been proposed to investigate the possibility to get a **low depletion voltage** and to **limit the leakage current** of heavily irradiated silicon devices



Simulation setup

Simulated device structure and parameters:

–Doping profiles:

- n-doped substrate ($7 \times 10^{11} \text{ cm}^{-3}$) → **6k0cm.**

- Charge concentration at the silicon-oxide interface of :

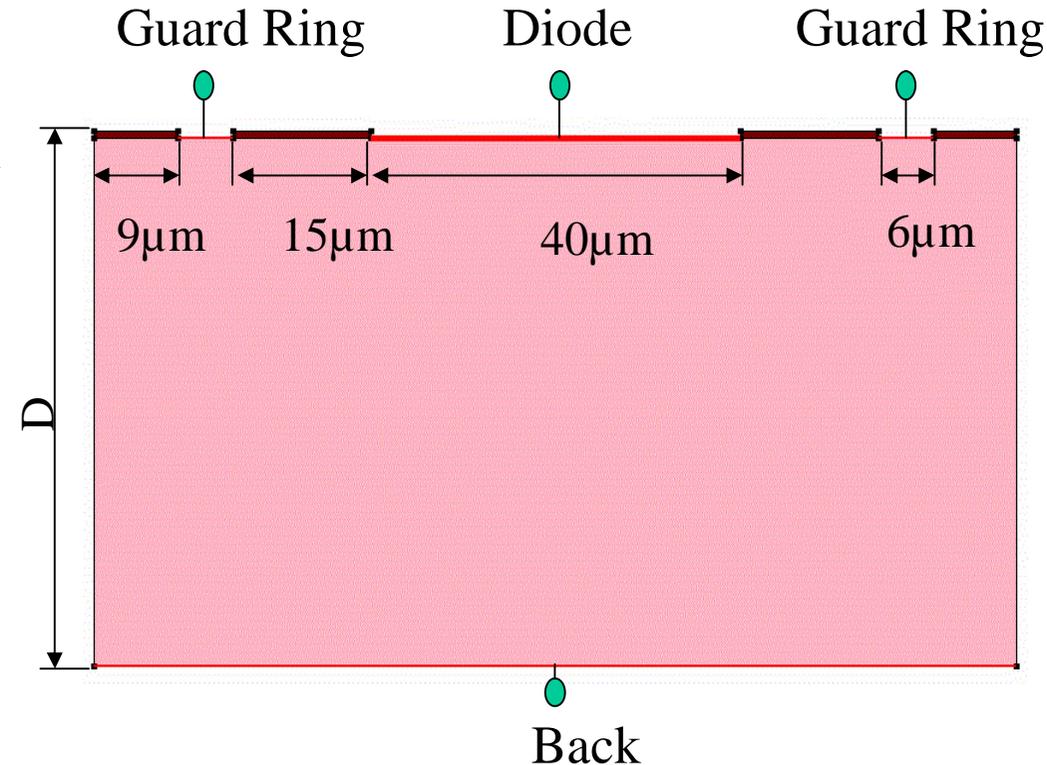
- $4 \times 10^{11} \text{ cm}^{-3}$ pre-irradiation

- $1 \times 10^{12} \text{ cm}^{-3}$ post-irradiation

–Optimized variable mesh definition

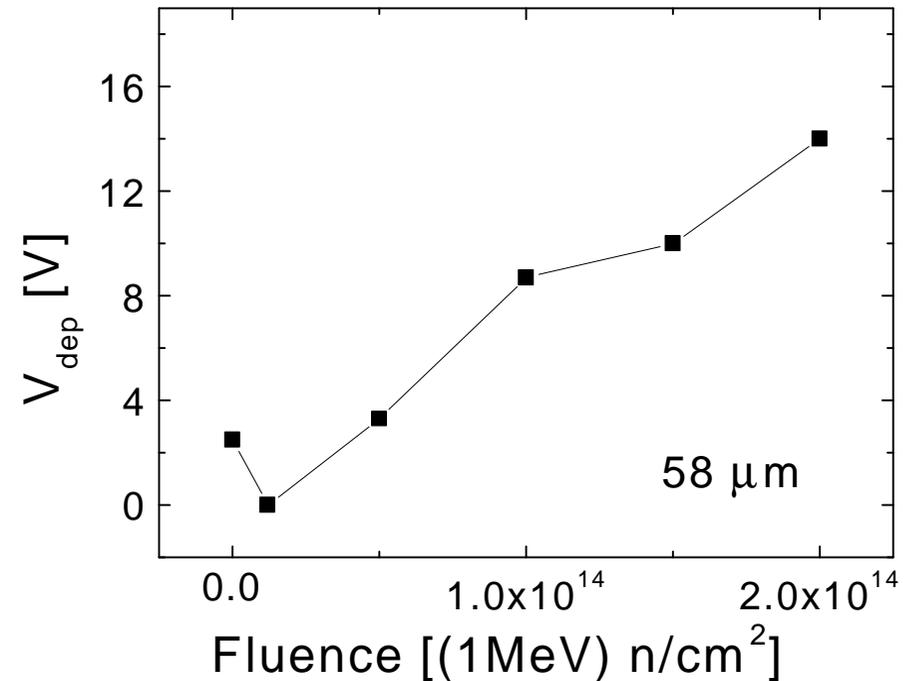
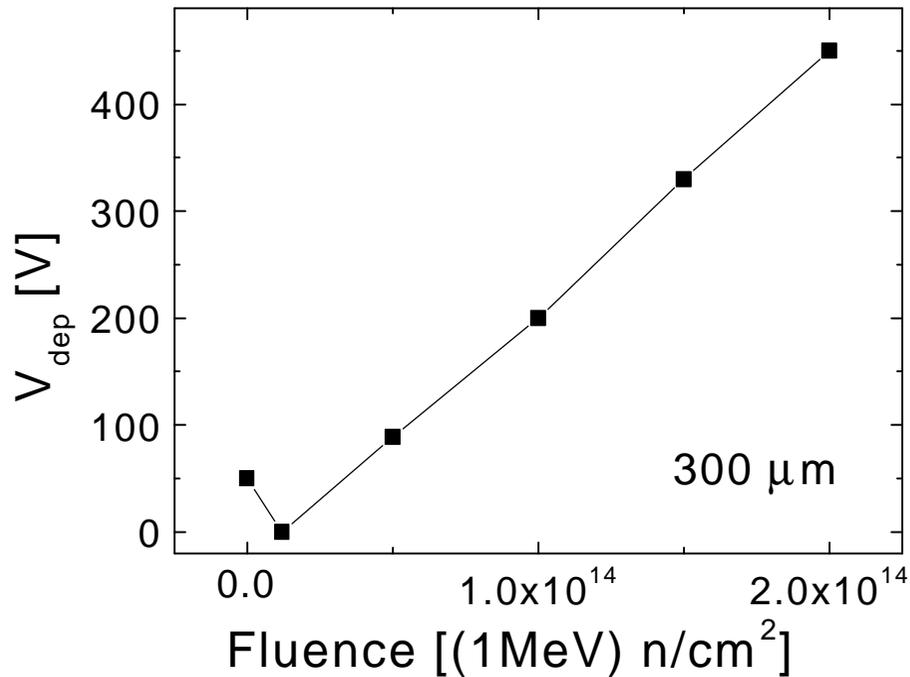
– Different thickness devices:

D = 20-50-100-200-300 μm



Simulation results

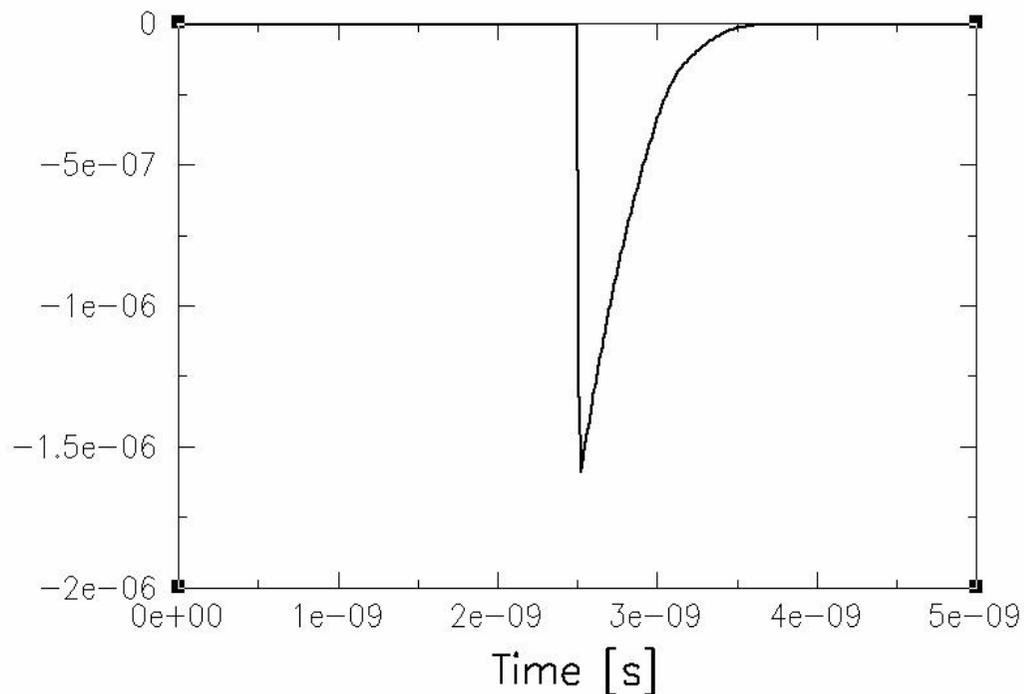
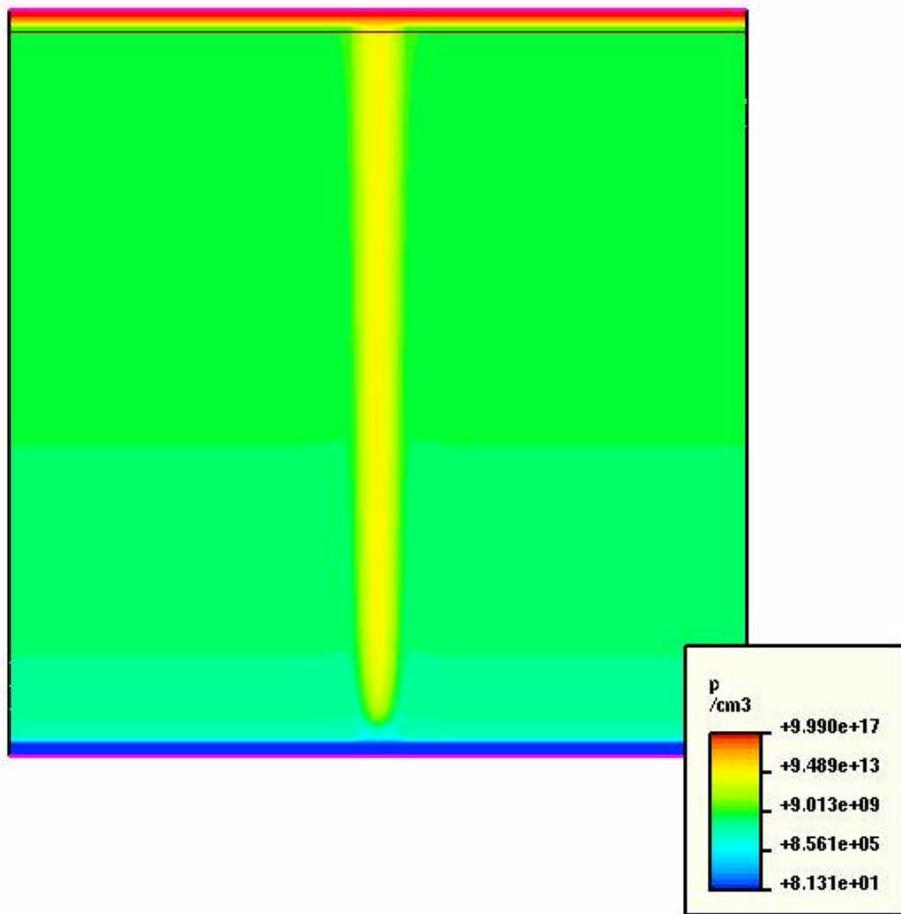
Simulated Depletion Voltage as a function of the fluence



- V_{dep} in thin structures is one order of magnitude lower than in thick one
- V_{dep} of thin diode at a fluence of 1×10^{15} n/cm² is about 120 V while in thick diode is more than 3000 V !



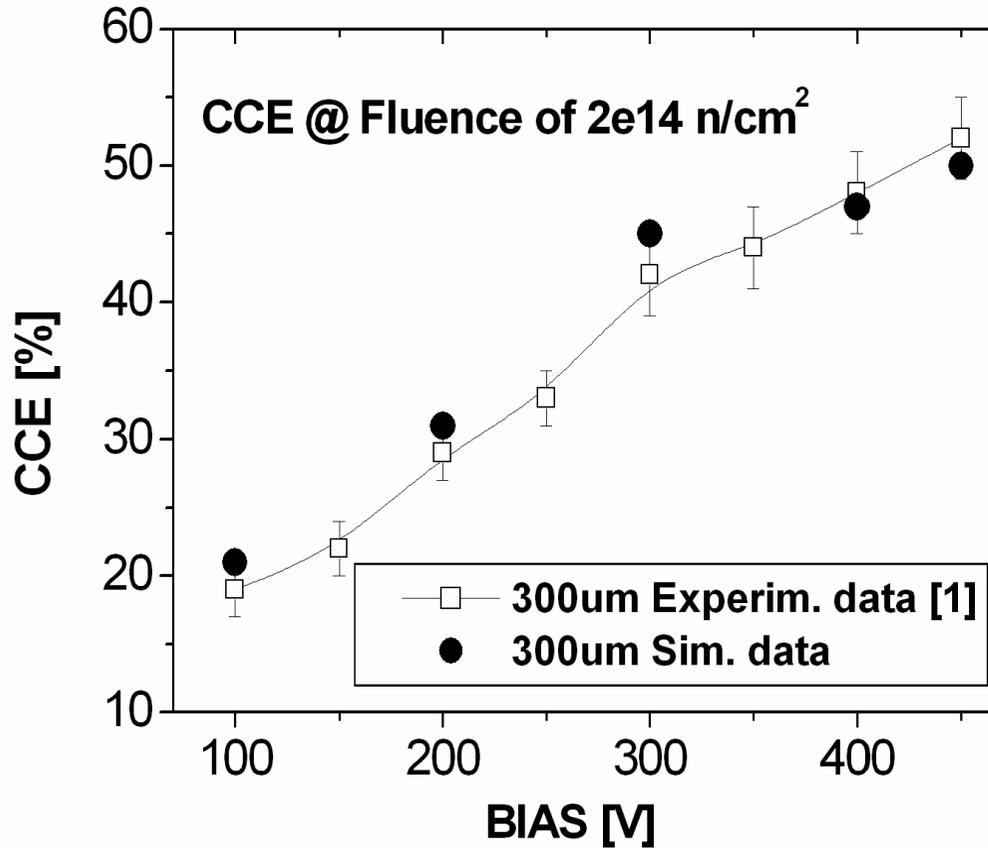
CCE Simulation results



MIP: 80 e-h pairs/ μm
Cylinder diameter = $2\mu\text{m}$



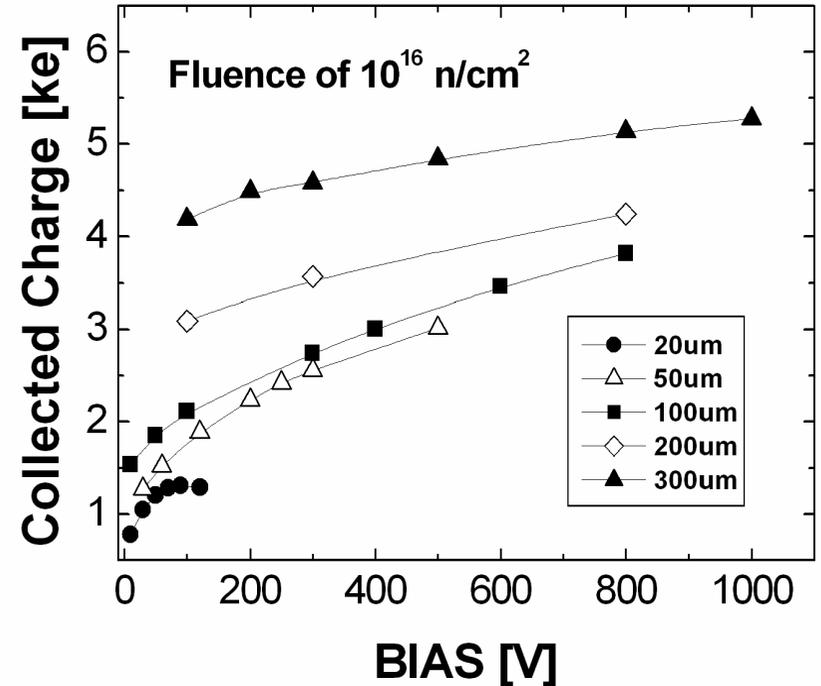
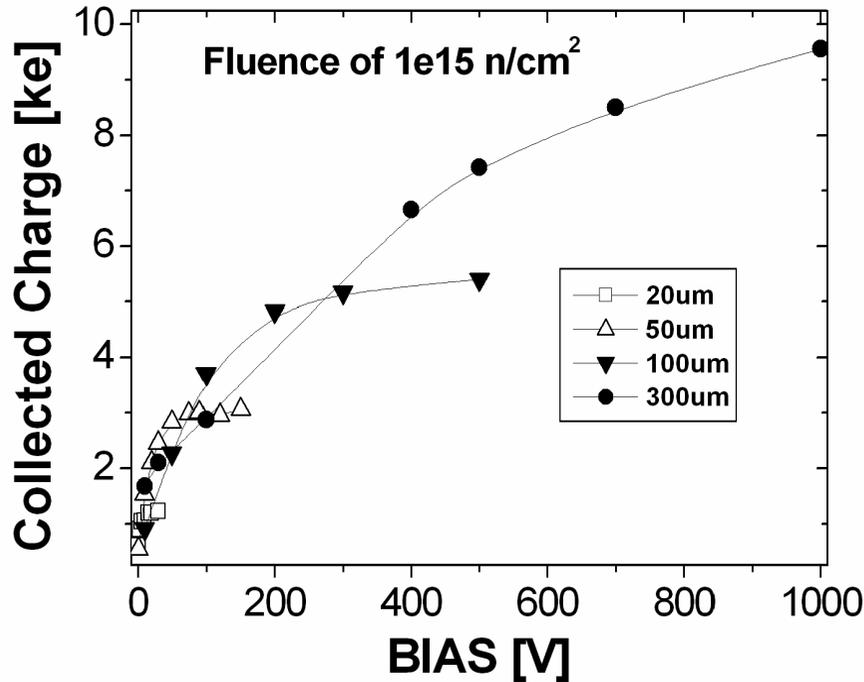
Simulated Collected Charge as a function of the applied Bias at 2×10^{14} n/cm² and Experimental data



Simulated data at fluence of 10^{14} reproduce experimental results [1]



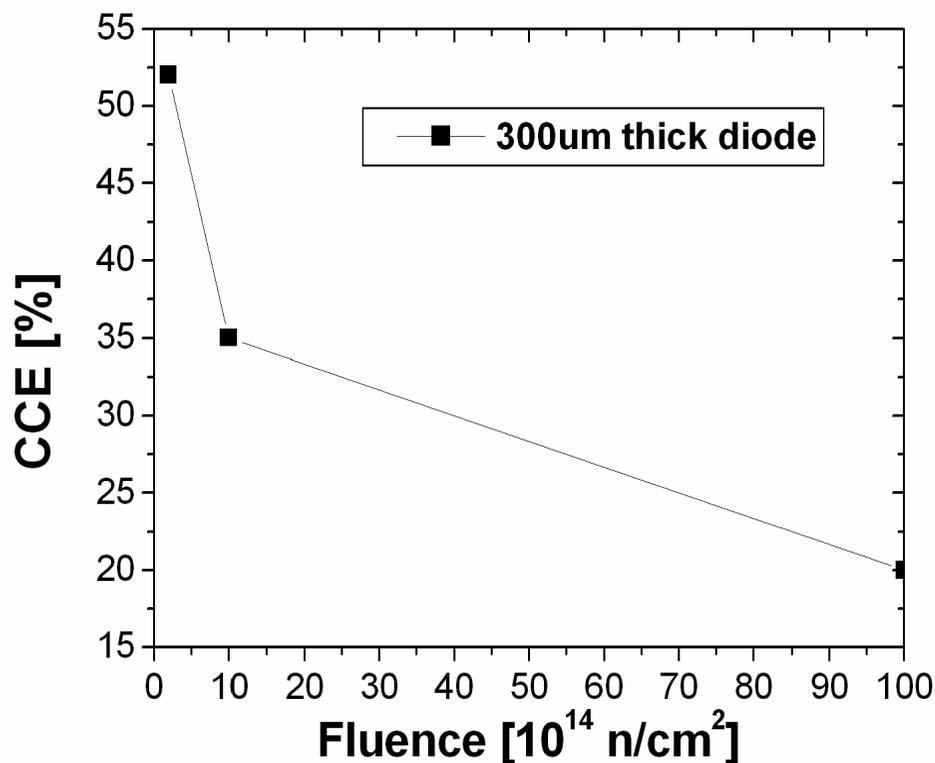
Simulated Collected Charge as a function of the applied Bias at 10^{15} and 10^{16} n/cm² Fluence



1. Simulated data at fluence of 10^{15} well reproduce experimental data [1,2] as confirmed also by results at RESMDD (66% @ 190V for 50 μ m thick p-on-n diode)
2. The simulation of a thinner structure (50 and 100 μ m) at higher fluence shows a saturation of the number of e-h pairs collected at the diode's electrode.



Simulated Charge Collection Efficiency as a function of the Fluence for thick diodes



- Simulated CCE as a function of Fluence ($2e14 - 1e15 - 1e16$ n/cm²) shows a no-linear slope
- The inefficiency rapidly decreasing would be caused by the high concentration of defects and by the partial depletion of the devices [Borchi – TNS vol.45 no.2 (98)]



Conclusions

- Irradiated thin and thick diodes have been analyzed considering a three levels simulation model up to $F=1e16$ n/cm²
- Thin features:
 - As known, V_{dep} in thin structures is one order of magnitude lower than thick diodes
 - The results suggest that an optimum thickness exists (50-100 um) which can maximize detector radiation hardness and signal-to-noise ratio.
- Next steps are:
 - Development of a new model for the p-type substrate based on the DLTS test which will be performed at the end of 2004 in Florence.

